

FET BIAS CONTROLLER WITH POLARISATION SWITCH AND TONE DETECTION

ISSUE 2 - JUNE 2006

ZNBG3115
ZNBG3116

DEVICE DESCRIPTION

The ZNBG series of devices are designed to meet the bias requirements of GaAs and HEMT FETs commonly used in satellite receiver LNBs, PMR, cellular telephones etc. with a minimum of external components.

With the addition of two capacitors and a resistor the devices provide drain voltage and current control for three external grounded source FETs, generating the regulated negative rail required for FET gate biasing whilst operating from a single supply. This negative bias, at -2.8 volts, can also be used to supply other external circuits.

The ZNBG3115/16 includes bias circuits to drive up to three external FETs. A control input to the device selects either one of two FETs as operational, the third FET is permanently active. This feature is normally used as an LNB polarisation switch. Also specific to Universal LNB applications is the 22kHz tone detection and logic output feature which is used to enable high and low band frequency switching.

The ZNBG3115/16 has been designed to cope with DiSEqC™ ready set top boxes and rejects all transients from channel switching.

Drain current setting of the ZNBG3115/16 is user selectable over the range 0 to 15mA, this is achieved with addition of a single resistor. The series also offers the choice of drain voltage to be set for the FETs, the 3115 gives 2.2 volts drain whilst the 3116 gives 2 volts.

These devices are unconditionally stable over the full working temperature with the FETs in place, subject to the inclusion of the recommended gate and drain capacitors. These ensure RF stability and minimal injected noise.

It is possible to use less than the devices full complement of FET bias controls, unused drain and gate connections can be left open circuit without affecting operation of the remaining bias circuits.

To protect the external FETs the circuits have been designed to ensure that, under any conditions including power up/down transients, the gate drive from the bias circuits cannot exceed the range -3.5V to 1V. Additionally each stage has its own individual current limiter. Furthermore if the negative rail experiences a fault condition, such as overload or short circuit, the drain supply to the FETs will shut down avoiding excessive current flow.

The ZNBG3115/16 are available in QSOP16 and QSOP20 for the minimum in device size. Device operating temperature is -40 to 80°C to suit a wide range of environmental conditions.

FEATURES

- Provides bias for GaAs and HEMT FETs
- Drives up to three FETs
- Dynamic FET protection
- Drain current set by external resistor
- Regulated negative rail generator requires only 2 external capacitors
- Choice in drain voltage
- Wide supply voltage range
- Polarisation switch for LNBs
- 22kHz tone detection for band switching
- Tone detector ignores unwanted signals
- Support for MIMIC, FET and Bipolar local oscillator devices
- Compliant with ASTRA control specifications
- QSOP 16 and 20 surface mount packages

APPLICATIONS

- Satellite receiver LNBs
- Private mobile radio (PMR)
- Cellular telephones

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ABSOLUTE MAXIMUM RATINGS

Supply Voltage	-0.6V to 12V
Supply Current	100mA
Input Voltage (V_{POL})	25V Continuous
Drain Current (per FET) (set by R_{CAL})	0 to 15mA
Operating Temperature	-40 to 80°C
Storage Temperature	-50 to 85°C

Power Dissipation ($T_{amb} = 25^{\circ}\text{C}$)

QSOP16	500mW
QSOP20	500mW

ELECTRICAL CHARACTERISTICS. TEST CONDITIONS

(Unless otherwise stated): $T_{amb} = 25^{\circ}\text{C}$, $V_{CC} = 5\text{V}$, $I_D = 10\text{mA}$ ($R_{CAL} = 33\text{k}\Omega$)

SYMBOL	PARAMETER	CONDITIONS	LIMITS			UNITS
			MIN.	TYP.	MAX.	
V_{CC}	Supply Voltage		5		10	V
I_{CC}	Supply Current	$I_{D1} = I_{D2} \text{ (or } I_{D12}) = I_{D3} = 0$		8.5	15	mA
		$I_{D1} = 0, I_{D2} \text{ (or } I_{D12}) = I_{D3} = 10\text{mA}, V_{POL} = 14\text{V}$		28	35	mA
		$I_{D2} = 0, I_{D1} \text{ (or } I_{D12}) = I_{D3} = 10\text{mA}, V_{POL} = 15.5\text{V}$		28	35	mA
		$I_{D1} \text{ and } I_{D3} = 0, I_{LB} = 10\text{mA}$		18	25	mA
		$I_{D1} \text{ and } I_{D3} = 0, I_{HB} = 10\text{mA}$		18	25	mA
V_{SUB}	Substrate Voltage	(Internally generated) $I_{CSUB} = 0$	-3.05	-2.8	-2.55	V
		$I_{CSUB} = -200\mu\text{A}$			-2.4	V
E_{ND}	Output Noise					
E_{NG}	Drain Voltage	$C_G = 4.7\text{nF}, C_D = 10\text{nF}$			0.02	Vpkpk
	Gate Voltage	$C_G = 4.7\text{nF}, C_D = 10\text{nF}$			0.005	Vpkpk
f_O	Oscillator Frequency		180	330	800	kHz

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SYMBOL	PARAMETER	CONDITIONS	LIMITS			UNITS
			MIN.	TYP.	MAX.	

GATE CHARACTERISTICS

I_{GO}	Output Current Range		-30		2000	NA
		I_{Dx} V_{POL} I_{GOx} (mA) (V) (A)				
V_{G1O}	Output Voltage					
V_{G1L}	Gate 1 Off	$I_{D1}=0$ $V_{POL}=14$ $I_{GO1}=-10$	-2.5	-2.25	-2.0	V
V_{G1H}	Low	$I_{D1}=12$ $V_{POL}=15.5$ $I_{GO1}=-10$	-2.5	-2.25	-2.0	V
	High	$I_{D1}=8$ $V_{POL}=15.5$ $I_{GO1}=0$	0.4	0.75	1.0	V
V_{G2O}	Output Voltage					
V_{G2L}	Gate 2 Off	$I_{D2}=0$ $V_{POL}=15.5$ $I_{GO2}=-10$	-2.5	-2.25	-2.0	V
V_{G2H}	Low	$I_{D2}=12$ $V_{POL}=14$ $I_{GO2}=-10$	-2.5	-2.25	-2.0	V
	High	$I_{D2}=8$ $V_{POL}=14$ $I_{GO2}=0$	0.4	0.75	1.0	V
V_{G3L}	Output Voltage					
V_{G3H}	Gate 3 Low	$I_{D3}=12$ $I_{GO3}=-10$	-3.0	-2.75	-2.5	V
	High	$I_{D3}=8$ $I_{GO3}=0$	0.4	0.75	1.0	V

DRAIN CHARACTERISTICS

I_D	Current		8	10	12	mA
I_{Drng}	Current range	Set by R_{cal}	0		15	mA
ΔI_{DV} ΔI_{DV}	Current Change with V_{CC} with T_j	$V_{CC}=5$ to $10V$ $T_j=-40$ to $+80^\circ C$		0.5 0.05		%/V %/°C
V_{D1}	Drain 1 Voltage: High ZNBG3115 ZNBG3116	$I_{D1}=10mA$, $V_{POL}=15.5V$ $I_{D1}=10mA$, $V_{POL}=15.5V$	2.0 1.8	2.2 2.0	2.4 2.2	V V
V_{D2}	Drain 2 Voltage: High ZNBG3115 ZNBG3116	$I_{D2}=10mA$, $V_{POL}=14V$ $I_{D2}=10mA$, $V_{POL}=14V$	2.0 1.8	2.2 2.0	2.4 2.2	V V
V_{D3}	Drain 3 Voltage: High ZNBG3115 ZNBG3116	$I_{D3}=10mA$, $V_{POL}=15.5V$ $I_{D3}=10mA$, $V_{POL}=15.5V$	2.0 1.8	2.2 2.0	2.4 2.2	V V
ΔV_{DV} ΔV_{DT}	Voltage Change with V_{CC} with T_j	$V_{CC}=5$ to $10V$ $T_j=-40$ to $+80^\circ C$		0.5 50		%/V ppm
I_{L1} I_{L2}	Leakage Current Drain 1 † Drain 2 †	$V_{D1}=0.5V$, $V_{POL}=14V$ $V_{D2}=0.5V$, $V_{POL}=15.5V$			10 10	NA NA

†QSOP20 only

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SYMBOL	PARAMETER	CONDITIONS	LIMITS			UNITS
			MIN.	TYP.	MAX.	

tone detection characteristics

V _{OUT}	Filter Amplifier Bias Voltage ⁵	I _{fin} =0	1.75	1.95	2.15	V
F _{inz}	Input Impedance	V _{FIN} =100mV p/p		150		Ω
AG	Amplifier Gain	V _{FIN} =100mV p/p		30		V/mA
FV _T	V Threshold ⁵		100	170	350	mV p/p
V _{LOV}	Output Stage L _{OV} Volt. Range ⁶	I _L =50mA(L _B or H _B)	-0.5		V _{CC} -1.8	V
I _{LOV}	L _{OV} Bias Current	V _{LOV} =0	0.02	0.15	1.0	μA
V _{LBL}	L _B Output Low	V _{LOV} =0 I _L =0 Enabled ⁶ R _{lb} -C _{sub} =1MΩ	-3.05	-2.80	-2.55	V
		V _{LOV} =3V I _L =0mA Enabled ⁶ R _{lb} -C _{sub} =1MΩ	-0.01	0	0.1	V
V _{LBH}	L _B Output High	V _{LOV} =0 I _L =10mA Disabled ⁶ V _{LOV} =3V I _L =50mA Disabled ⁶	-0.025 2.9	0 3.0	0.025 3.1	V V
V _{HBL}	H _B Output Low	V _{LOV} =0 I _L =0 Disabled ⁶ R _{hb} -C _{sub} =1MΩ	-3.05	-2.80	-2.55	V
		V _{LOV} =3V I _L =0 Disabled ⁶ R _{hb} -Gnd=1MΩ	-0.01	0	0.1	V V
V _{HBH}	H _B Output High	V _{LOV} =0 I _L =10mA Enabled ⁶ V _{LOV} =3V I _L =50mA Enabled ⁶	-0.025 2.9	0 3.0	0.025 3.1	V V

POLARITY SWITCH CHARACTERISTICS

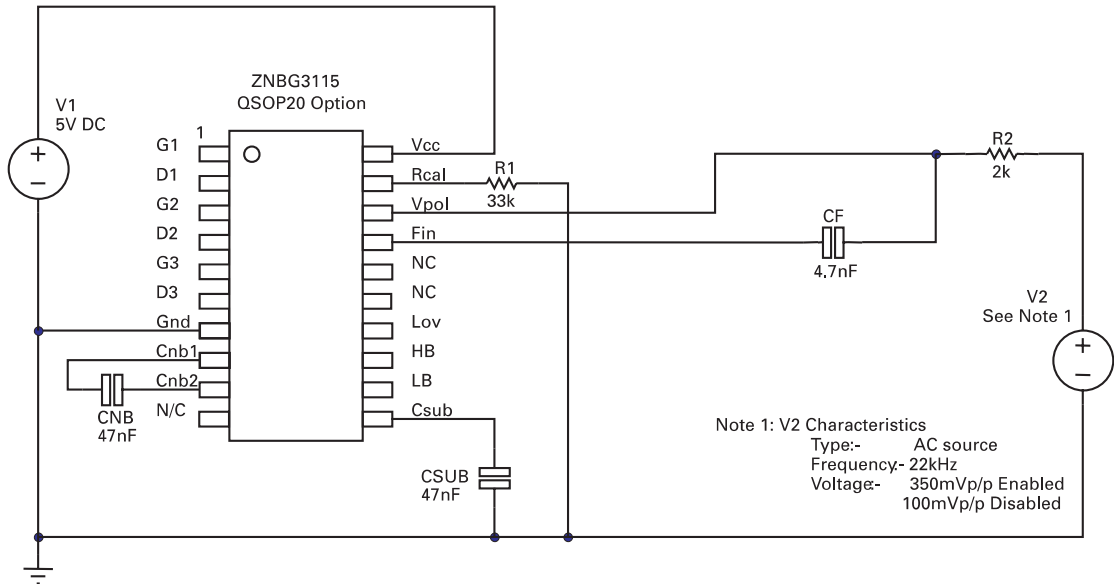
I _{POL}	Input Current	V _{POL} =25V (Applied via R _{POL} =2kΩ)	10	25	40	μA
V _{TPOL}	Threshold Voltage	V _{POL} =25V (Applied via R _{POL} =2kΩ)	14	14.75	15.5	V
T _{SPOL}	Switching Speed	V _{POL} =25V (Applied via R _{POL} =2kΩ)			100	ms

NOTES:

1. The negative bias voltages specified are generated on-chip using an internal oscillator. Two external capacitors, C_{NB} and C_{SUB}, of 47nF are required for this purpose.
2. The characteristics are measured using an external reference resistor R_{CAL} of value 33k wired from pins R_{CAL} to ground.
3. Noise voltage is not measured in production.
4. Noise voltage measurement is made with FETs and gate and drain capacitors in place on all outputs. C_G, 4.7nF, are connected between gate outputs and ground, C_D, 10nF, are connected between drain outputs and ground.
5. These parameters are linearly related to V_{CC}.
6. These parameters are measured using Test Circuit 1

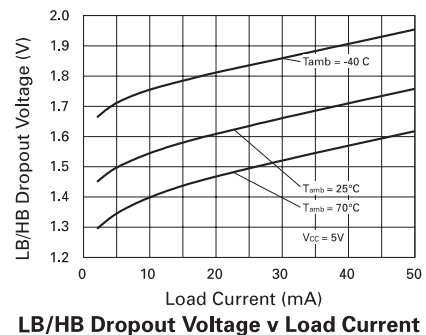
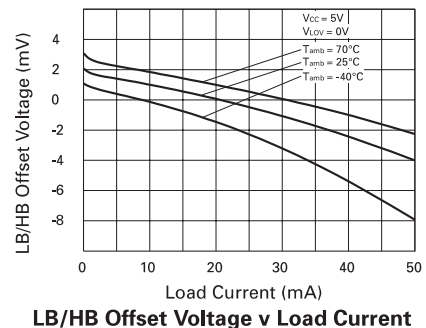
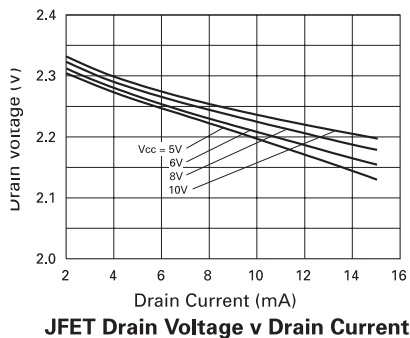
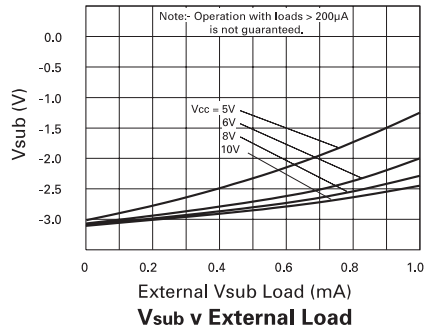
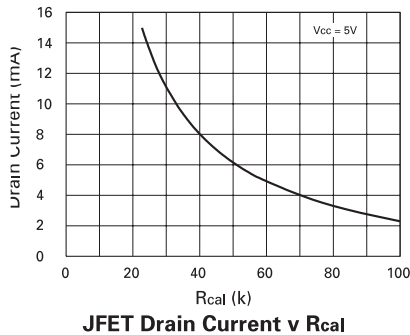
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TEST CIRCUIT 1

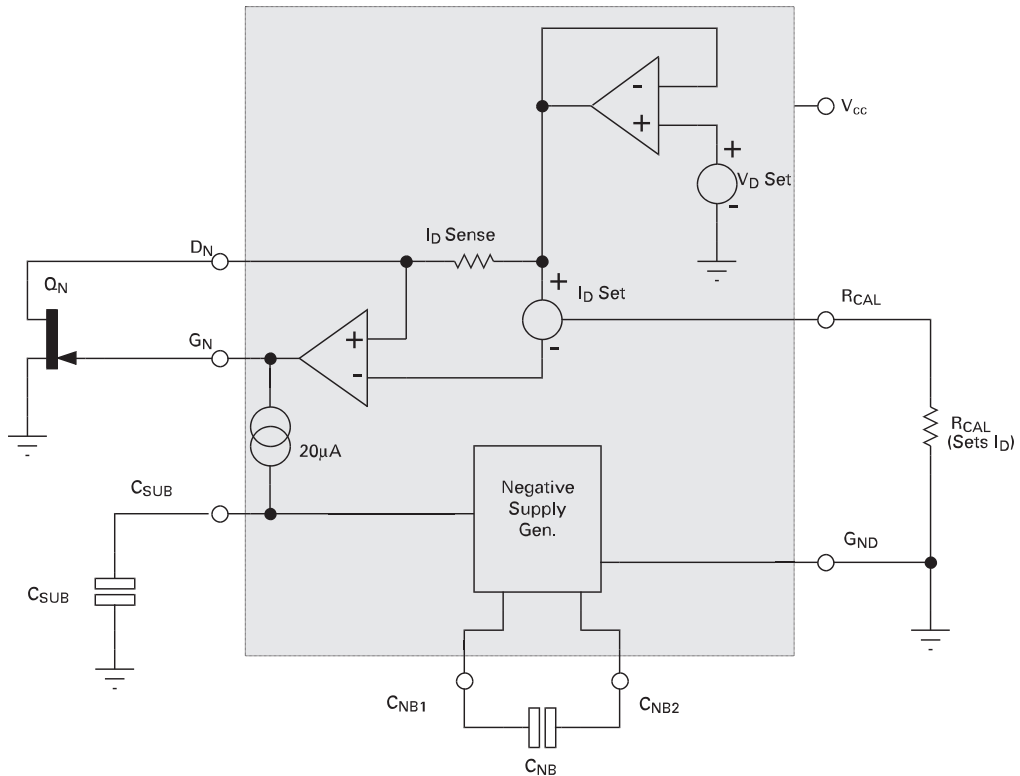


Note: Same circuit used for QSOP16 option but with adjusted pinout.

TYPICAL CHARACTERISTICS



FUNCTIONAL DIAGRAM



FUNCTIONAL DESCRIPTION

The ZNBG devices provide all the bias requirements for external FETs, including the generation of the negative supply required for gate biasing, from the single supply voltage. The diagram above shows a single stage from the ZNBG series. The ZNBG3115/16 contains 3 such stages. The negative rail generator is common to both devices.

The drain voltage of the external FET Q_N is set by the ZNBG device to its normal operating voltage. This is determined by the on board V_D Set reference, for the ZNBG3115 this is nominally 2.2 volts whilst the ZNBG3116 provides nominally 2 volts.

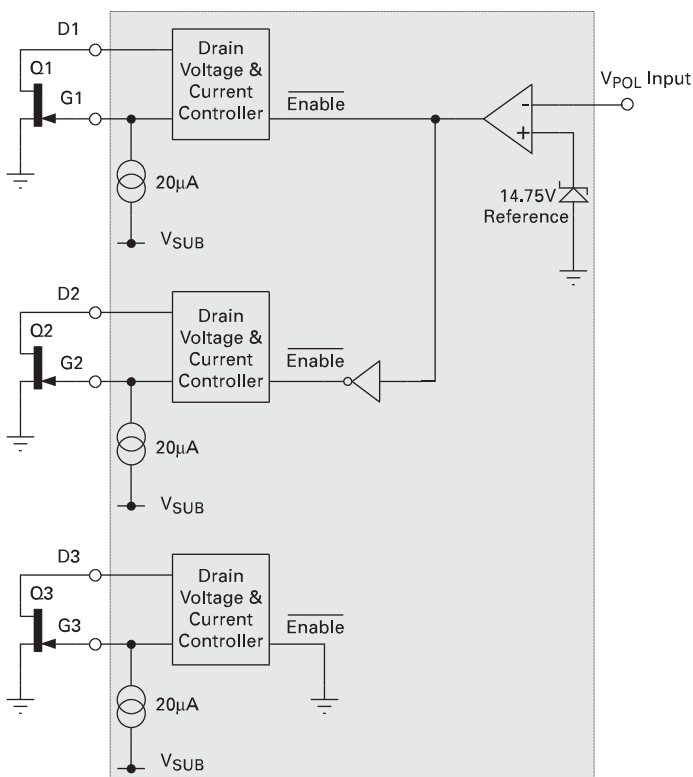
The drain current taken by the FET is monitored by the low value resistor I_D Sense. The amplifier driving the gate of the FET adjusts the gate voltage of Q_N so that the drain current taken matches the current called for by an external resistor R_{CAL} .

Since the FET is a depletion mode transistor, it is often necessary to drive its gate negative with respect to ground to obtain the required drain current. To provide this capability from a single positive supply, the device includes a low current negative supply generator. This generator uses an internal oscillator and two external capacitors, C_{NB} and C_{SUB} .

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The following schematic shows the function of the V_{POL} input. Only one of the two external FETs numbered Q1 and Q2 are powered at any one time, their selection is controlled by the input V_{POL} . This input is designed to be wired to the power input of the LNB via a high value (10k) resistor. With the input voltage of the LNB set at or below 14V, FET Q2 will be enabled. With the input voltage at or above 15.5V, FET Q1 will be enabled. The disabled FET has its gate driven low and its drain terminal is switched open circuit. It is permissible to connect the drain pins D1 and D2 together if required by the application circuit; this is done internally in the QSOP16 version. FET number Q3 is always active regardless of the voltage applied to V_{POL} .



QSOP 20 Version

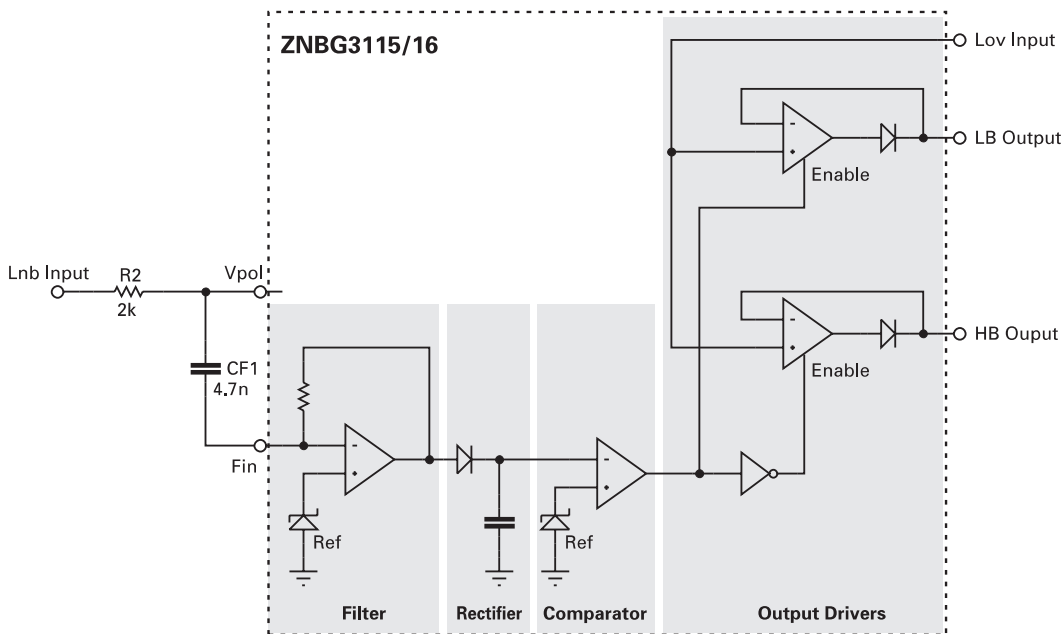
Control Input Switch Function

Input Sense	Polarisation	Select
≤ 14 volts	Vertical	FET Q2
≥ 15.5 volts	Horizontal	FET Q1

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For many LNB applications, tone detection for band switching is required. The ZNBG3115/16 includes all the circuitry necessary to detect the presence of a 22kHz tone modulated on the supply input to the LNB. The main elements of the detector are an op-amp, a rectifier/smoothen and a comparator. The op-amp has a pre-set internal feedback resistor so that just a simple RC network wired to the input gives user defined gain and low frequency cut filter characteristics. The RC network components also serve two other purposes. The resistor provides overvoltage protection for the Vpol pin and the capacitor minimises tone interference of the Vpol threshold. The upper frequency roll-off of the op-amp has been set internally at above 100kHz to allow the amplifier to be used with other common tone switch frequencies.

The rectifier/smoothen/comparator function is provided by a complex propriety circuit that allows the ZNBG3115/16 to reliably detect wanted tones whilst ignoring low frequency square wave switch box signals, DiSEqC™ bursts and supply switching transients common when using DiSEqC-2™ ready set-top boxes. This is all achieved without the need for any further external components. The threshold of the comparator is supply dependent, hence the gain of the preceding op-amp must be adjusted in line with supply voltage. See the table below for recommended values for 22kHz detection, given for a range of supplies.



Table_1

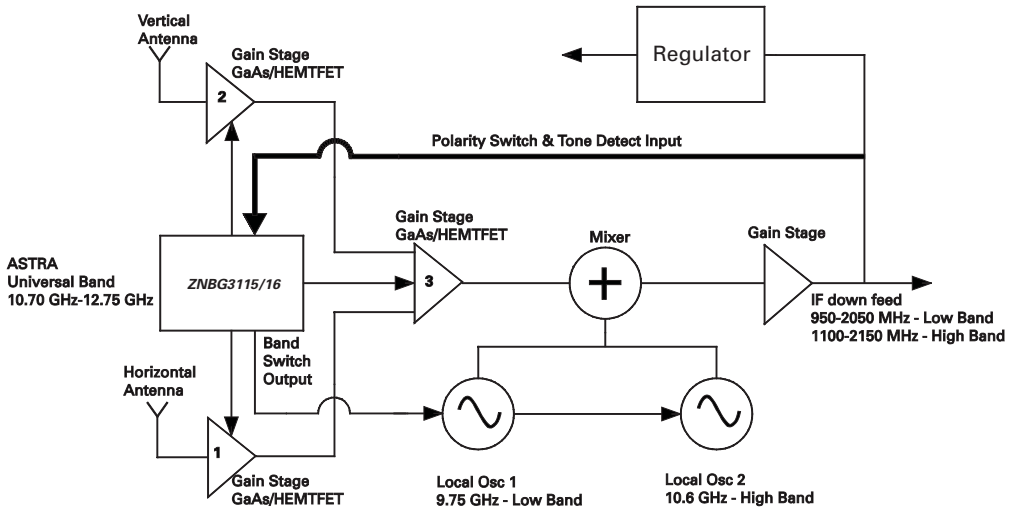
Filter Components	Supply Voltage (Vcc)					
	5V	6V	7V	8V	9V	10V
Cf	4.7nF	4.7nF	4.7nF	10nF	10nF	10nF
Rvpol (R2)	2k	1.8k	1.5k	1.3k	1.1k	1.0k

Note: Optimised for F(tone) = 22kHz.

APPLICATIONS INFORMATION(cont)

The following block diagram shows the main section of an LNB designed for use with the Astra series of satellites. The ZNBG3115/16 is the core bias and control element of this circuit. The ZNBG provides the negative rail, FET bias control, polarisation switch control, tone detection and band switching with the minimum of external components. Compared to other discrete component solutions the ZNBG circuit reduces component count and overall size required.

Single Universal LNB Block Diagram



Tone detection and band switching is provided on the ZNBG3115/16 devices. The following diagrams describes how this feature operates in an LNB and the external components required. The presence or absence of a 22kHz tone applied to pin F_{IN} enables one of two outputs, L_B and H_B . A tone present enables H_B and tone absent enables L_B . The L_B and H_B outputs are designed to be compatible with both MMIC and discrete (bipolar or FET) local oscillator applications, selected by pin L_{OV} . Referring to Figure 1 wiring pin L_{OV} to ground will force L_B and H_B to switch between -2.6V (disabled) and 0V (enabled). Referring to Figures 2 and 3 wiring pin L_{OV} to a positive voltage source (e.g. a potential divider across V_{CC} and ground set to the required oscillator supply voltage, V_{OSC}) will force the L_B and H_B outputs to provide the required oscillator supply, V_{OSC} , when enabled and 0V when disabled.

Tone Detection Function

L_{OV}	F_{IN}	L_B	H_B	L_B	H_B
G_{ND}	22kHz	Disabled	Enabled	-3 volts	G_{ND}
	—	Enabled	Disabled	G_{ND}	-3 volts
V_{OSC}	22kHz	Disabled	Enabled	Note 1	V_{OSC}
	—	Enabled	Disabled	V_{OSC}	Note 1

Note 1: 0 volts in typical LNB applications but dependent on external circuits.

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APPLICATIONS Local Oscillator Circuits

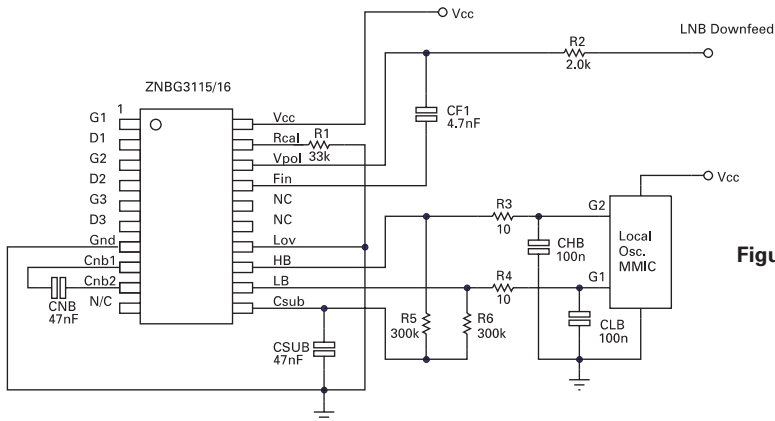


Figure 1

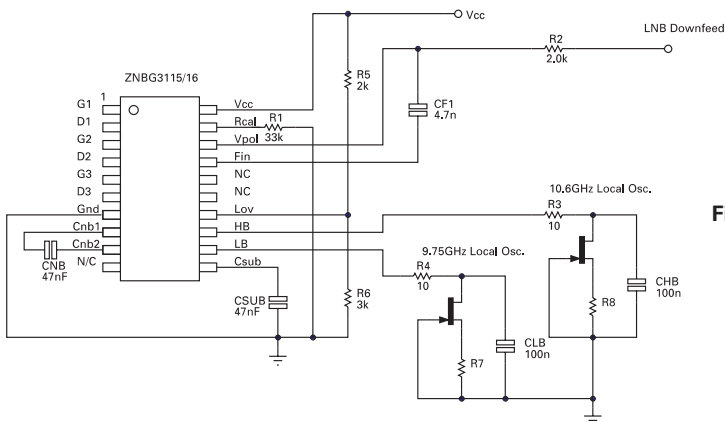


Figure 2

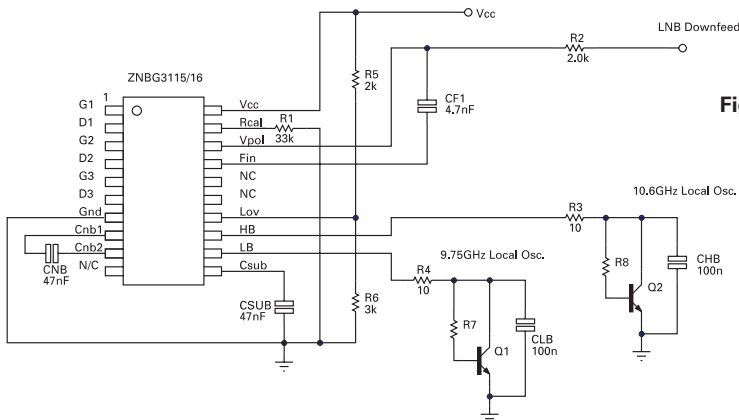
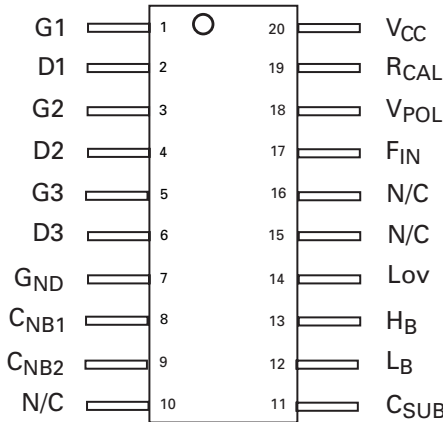


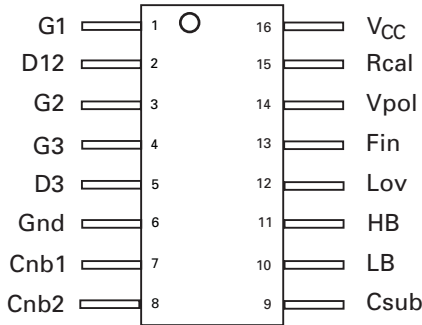
Figure 3

CONNECTION DIAGRAM

QSOP20



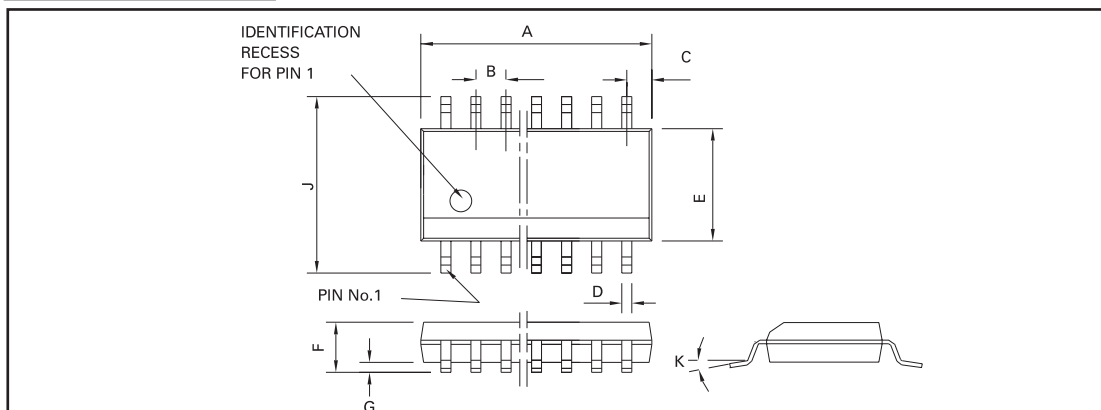
QSOP16



Part Number	Package	Part Mark
ZNBG3115Q16	QSOP16	ZNBG3115
ZNBG3116Q16	QSOP16	ZNBG3116
ZNBG3115Q20	QSOP20	ZNBG3115
ZNBG3116Q20	QSOP20	ZNBG3116

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ZNBG3116



QSOP16

DIM	Millimetres		Inches	
	MIN	MAX	MIN	MAX
A	4.80	4.98	0.189	0.196
B	0.635		0.025 NOM	
C	0.23 REF		0.009 REF	
D	0.20	0.30	0.008	0.012
E	3.81	3.99	0.15	0.157
F	1.35	1.75	0.053	0.069
G	0.10	0.25	0.004	0.01
J	5.79	6.20	0.228	0.244
K	0°	8°	0°	8°

Conforms to JEDEC MO-137AB Iss A

QSOP20

DIM	Millimetres		Inches	
	MIN	MAX	MIN	MAX
A	8.55	8.74	0.337	0.344
B	0.635		0.025 NOM	
C	1.47 REF		0.058 REF	
D	0.20	0.30	0.008	0.012
E	3.81	3.99	0.15	0.157
F	1.35	1.75	0.053	0.069
G	0.10	0.25	0.004	0.01
J	5.79	6.20	0.228	0.244
K	0°	8°	0°	8°

Conforms to JEDEC MO-137AD Iss A

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Europe	Americas	Asia Pacific	Corporate Headquarters
Zetex GmbH Streitfeldstraße 19 D-81673 München Germany	Zetex Inc 700 Veterans Memorial Hwy Hauppauge, NY 11788 USA	Zetex (Asia) Ltd 3701-04 Metroplaza Tower 1 Hing Fong Road, Kwai Fong Hong Kong	Zetex Semiconductors plc Zetex Technology Park Chadderton, Oldham, OL9 9LL United Kingdom
Telefon: (49) 89 45 49 49 0 Fax: (49) 89 45 49 49 49 europe.sales@zetex.com	Telephone: (1) 631 360 2222 Fax: (1) 631 360 8222 usa.sales@zetex.com	Telephone: (852) 26100 611 Fax: (852) 24250 494 asia.sales@zetex.com	Telephone (44) 161 622 4444 Fax: (44) 161 622 4446 hq@zetex.com

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